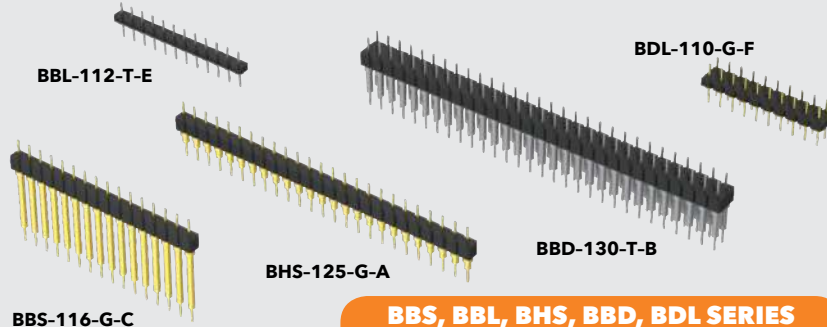




BBS, BBL, BHS, BBD, BDL SERIES

MACHINED BOARD STACKING STRIPS

SS, SD, HSS, SL, SDL,
ESS, ESD

FEATURES

- Low profile design achieves (3.89 mm) .153" board spacings when mated with SL Series.
- Approach the reliability of a permanent connection with the flexibility of a separable connection.

SPECIFICATIONS

For complete specifications
see www.samtec.com?BBS,
www.samtec.com?BBL,
www.samtec.com?BHS
www.samtec.com?BBD or
www.samtec.com?BDL

Insulator Material:
Black Liquid Crystal Polymer
(BBL, BHS)
Black Glass Filled Polyester
(BBS, BBD, BDL)

Temperature Range:
-55 °C to +125 °C

Terminal Material:
Phosphor Bronze or Brass

Plating:

Plating:
Au or Sn over

50 μ'' (1.27 μm) Ni

Lead-Free Solderable

Yes (BBL, BDL, BHS-S)

No, Lead Wave only
(PDC, PPD, PUC, N)

(BBS, BBD, BHS-N)

RECOGNITIONS

For complete scope
of recognitions see
www.samtec.com/quality



Note:
Some lengths, styles and options are non-standard, non-returnable.

TYPE STRIP	1	NO. PINS PER ROW	PLATING OPTION	LEAD STYLE
BBS = Standard Single Row			-G = 20 μ" (0.51 μm) Gold	
BBL = Low Profile Single Row			-T = Tin	
BHS = High Temp Single Row				
BBD = Standard Double Row				
BDL = Low Profile Double Row			01 thru 32 = BBS & BBL	01 thru 36 = BBD, BDL & BHS

-A
Z = (5.33 mm) .210"

-B
Z = (8.51 mm) .335"

-C
Z = (14.86 mm) .585"

BBS and BHS Series

BBL Series

BDL Series

-E
Z = (1.78 mm) .070"

-F
Z = (2.16 mm) .085"